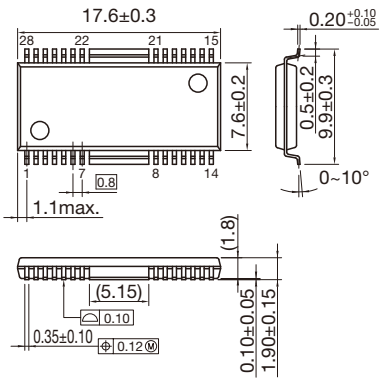
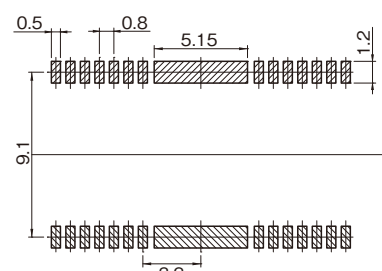
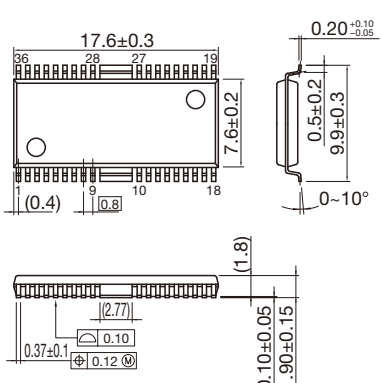
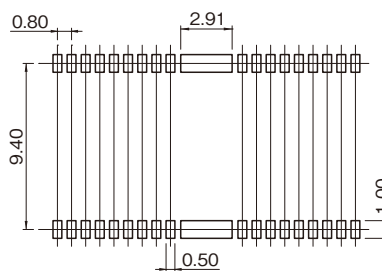


封装

封装名	外形尺寸图	推荐焊盘尺寸图
HSOP-28C	 HSOP-28C package drawing showing top, side, and bottom views with dimensions. Top view: 17.6±0.3, 7.6±0.2, 0.20^{+0.10}_{-0.05}, 0.5±0.2, 9.9±0.3, 0~10°, 1.1max., 0.8, 7, 8, 14, 15, 21, 22, 28. Side view: 0.10±0.05, 1.90±0.15, 0.35±0.10, 0.12, 0.10, 5.15, 1.8. Bottom view: 0.35±0.10, 0.12, 0.10, 5.15, 1.8.	 HSOP-28C recommended pad dimensions diagram showing dimensions: 0.5, 0.8, 5.15, 1.2, 9.1, 3.2.
HSOP-36A	 HSOP-36A package drawing showing top, side, and bottom views with dimensions. Top view: 17.6±0.3, 7.6±0.2, 0.20^{+0.10}_{-0.05}, 0.5±0.2, 9.9±0.3, 0~10°, 0.4, 9, 10, 18, 27, 28, 36. Side view: 0.10±0.05, 1.90±0.15, 0.37±0.1, 0.12, 0.10, 2.77, 1.8. Bottom view: 0.37±0.1, 0.12, 0.10, 2.77, 1.8.	 HSOP-36A recommended pad dimensions diagram showing dimensions: 0.80, 2.91, 9.40, 1.00, 0.50.